SN74AHCT240-Q1 **OCTAL BUFFER/DRIVER** WITH 3-STATE OUTPL

SCLS582B - APRIL 2004 - REVISED APRIL 2008

- **Qualified for Automotive Applications**
- Inputs Are TTL-Voltage Compatible
- Latch-Up Performance Exceeds 250 mA Per JESD 17

description/ordering information

This octal buffer/driver is designed specifically to improve the performance and density of 3-state memory-address drivers, clock drivers, and bus-oriented receivers and transmitters.

The SN74AHCT240 device is organized as two 4-bit buffers/line drivers with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes data from the A inputs to the Y outputs. When OE is high, the outputs are in the high-impedance state.

PW PACKAGE (TOP VIEW)									
1OE 1A1 2Y4 1A2 2Y3 1A3 2Y2 1A4 2Y1 GND	1 2 3	σ	20 19 18 17 16 15 14 13 12 11	V <u>CC</u> 20E 1111 244 1122 243 1123 242 114 241					

To ensure the high-impedance state during power up or power down, \overline{OE} shall be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION[†]

TA	PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
$-40^{\circ}C$ to $85^{\circ}C$	TSSOP – PW	Tape and reel	SN74AHCT240IPWRQ1	AHCT240I	

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

[‡]Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.

(each 4-bit buffer/driver)							
INP	JTS	OUTPUT					
OE	Α	Y					
L	Н	L					
L	L	Н					
Н	Х	Z					

FUNCTION TABLE (each 4-bit buffer/driver)



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

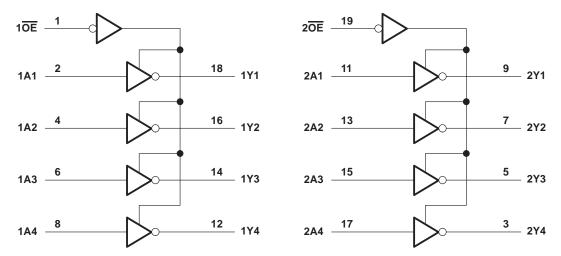


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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} Input voltage range, V _I (see Note 1)	
Output voltage range, V _O (see Note 1)	
Input clamp current, I _{IK} (V _I < 0)	–20 mA
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC})	±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V _{CC} or GND	±75 mA
Package thermal impedance, θ_{JA} (see Note 2)	83°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	V
VIH	High-level input voltage	2		V
VIL	Low-level input voltage		0.8	V
VI	Input voltage	0	5.5	V
VO	Output voltage	0	VCC	V
IOH	High-level output current		-8	mA
IOL	Low-level output current		8	mA
TA	Operating free-air temperature	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				Т	₄ = 25°C	;		MAX	
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	UNIT		
Maria	I _{OH} = -50 μA		4.5.1/	4.4	4.5		4.4		
VOH	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		V	
	I _{OL} = 50 μA I _{OL} = 8 mA		4.5.1			0.1		0.1	
VOL			4.5 V		0.36			0.44	V
I _{OZ}	$V_{O} = V_{CC}$ or GND		5.5 V			±0.25		±2.5	μA
lj –	$V_I = 5.5 V \text{ or GND}$		0 V to 5.5 V			±0.1		±1	μA
ICC	$V_I = V_{CC}$ or GND, $I_O =$	0	5.5 V			4		40	μA
$\Delta I C C^{\dagger}$	One input at 3.4 V, Other inputs at V _{CC} or GND		5.5 V			1.35		1.5	mA
Ci	$V_I = V_{CC}$ or GND		5 V		2.5	10		10	pF
Co	$V_{O} = V_{CC}$ or GND		5 V		3				pF

[†] This is the increase in supply current for each input at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

	FROM	то	LOAD	TA	= 25°C				
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
^t PLH	•	Y	0. 45 - 5		5.4	7.4	1	8.5	
^t PHL	A	ř	C _L = 15 pF		5.4	7.4	1	8.5	ns
^t PZH	OE	V	0. 45 - 5		7.7	10.4	1	12	
t _{PZL}	ÛE	Y	C _L = 15 pF		7.7	10.4	1	12	ns
^t PHZ	OE	Y	C _L = 15 pF		8.3	10.4	1	12	20
^t PLZ	UE	T	0L = 13 pr		8.3	10.4	1	12	ns
^t PLH		N.			5.9	8.4	1	9.5	
^t PHL	A	Y	C _L = 50 pF		5.9	8.4	1	9.5	ns
^t PZH		N.			8.2	11.4	1	13	
tpzl	de y		C _L = 50 pF		8.2	11.4	1	13	ns
^t PHZ		X	0 50 5		8.8	11.4	1	13	
tplz	OE	Y	Y C _L = 50 pF		8.8	11.4	1	13	ns
t _{sk(o)}			C _L = 50 pF			1		1	ns

noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 4)

	PARAMETER				UNIT
VOH(V)	Quiet output, minimum dynamic V _{OH}		4.1		V
V _{IH(D)}	High-level dynamic input voltage	2			V
V _{IL(D)}	Low-level dynamic input voltage			0.8	V

NOTE 4: Characteristics are for surface-mount packages only.

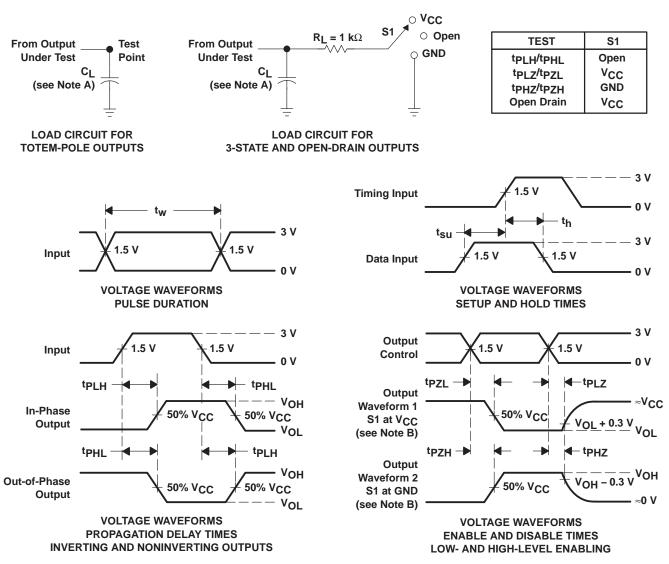
operating characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER		ONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance	No load,	f = 1 MHz	10	pF



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: $PRR \le 1$ MHz, $Z_{O} = 50 \Omega$, $t_{f} \le 3$ ns, $t_{f} \le 3$ ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins F	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CAHCT240IPWRG4Q1	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT240IPWRQ1	ACTIVE	TSSOP	PW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN74AHCT240-Q1 :

Catalog: SN74AHCT240

• Military: SN54AHCT240

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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